



## Cryogenic Heat Sink for Helium Gas Cooled Superconducting Power Devices

Presentation at the COMSOL Conference 2012 Boston, 3 – 5 October 2012

L. Graber<sup>1</sup>, D. Shah<sup>1</sup>, D.G. Crook<sup>1</sup>, C.H. Kim<sup>1</sup>, N.G. Suttell<sup>1</sup>, J. Ordonez<sup>1</sup>, S. Pamidi<sup>1</sup> <sup>1</sup>Center for Advanced Power Systems, Florida State University

Excerpt from the Proceedings of the 2012 COMSOL Conference in Boston





### Introduction

- Superconducting power cables cooled by helium gas
- Challenges in cable termination
- Application of the heat sink
- Finite element model
  - 2D heat transfer
  - 3D fluid flow
- Experiment for model validation
- Conclusions





- Superconducting cables for shipboard power system
  - Temperatures below LN2  $\rightarrow$  higher current density
  - Liquid cryogens not permitted (asphyxiation & explosion hazard)
  - Solution: Helium gas at 50...60 K and 1.8 MPa; flow rate up to 20 g/s
- gHe has lower heat capacity than LN2
  - Cooling more challenging, especially at terminations





## **Model Heat Sink**





#### Problem:

- Heat influx from ambient
- Joule heating in bushing
- Solution:
  - Heat intercept attached to copper conductor
  - Cold He gas flow through heat sink
- Design:
  - Finned heat sink inside tube
  - Entirely made from copper
  - Design and dimensions need to be optimized by FEA
  - Small-scale model built for model validation

# CONFERENCE Finite Element Model: 2D Heat Transfer



**Goal**: Determine optimal number of fins **Symmetry**: All BC for ½ heat sink



Physics

- Heat Transfer in Solids
- No CFD, but

#### Boundary conditions

- Heat influx 50 W
- Symmetry
- Insulation (vacuum)
- In channels: Convective cooling boundary condition (h = 90 W/m<sup>2</sup>K for the 9-fin model, obtained by Dittus-Boelter correlation)
- Initial temperature: 50 K
- Material properties
  - Copper:  $k, c_p, \rho$  as a function of temperature
- Mesh size: normal (2986 elements for 9-fin model)
- Pressure drop calulated separately using Moody Diagram





- Maximum heat sink temperature and pressure drop as a function of number of fins for three different mass flow rates
- 9 Fins seem to be optimal
- Flow rates of below 1 g/s are sufficient (50 W input power)



## Finite Element Model: 3D Fluid Flow





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Made from copper

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- Most parts mechanically machined
- Fins were machined by EDM
- Joined by silver braze (optimal heat transfer; leak free)
- Heater based on resistance wire
- Wrapped in aluminized Mylar
- Installed in vacuum chamber









	50 W for full HS		100 W for full HS	
Parameter	Model	Experiment	Model	Experiment
Temperature inlet [K]	58.6	58.6	65.5	65.5
Temperature increase [K]	4.15	4.7	6.45	7.3
Temp. heat sink [K]	63.0	77.3	73.8	84.0
Pressure drop [Pa]	284	294	313	297

- Generally good agreement between simulation results and measurements
  - Except for heat sink temperature
  - Investigations under way to determine the reason for discrepancy (Model or measurement?)





- The chosen geometry is suitable
  - Low pressure drop
  - Excellent heat transfer
  - Higher flow rates for turbulent flow are under investigation
- The developed models are very useful tools for heat sink design and optimization
  - It will be used for a real application in near future
- Model will be extended to incorporate turbulent flow
- Optimization studies for geometrical parameters (non-uniform spacing of fins; thickness of fins)